SiP32411

RoHS

COMPLIANT

HALOGEN



Vishay Siliconix

2 A, 1.2 V, Slew Rate Controlled Load Switch

DESCRIPTION

The SiP32411 is a slew rate controlled load switch that is designed for 1.1 V to 5.5 V operation.

The device guarantees low switch on-resistance at 1.2 V input. It features a controlled soft-on slew rate of typical 150 µs that limits the inrush current for designs of capacitive load or noise sensitive loads.

The device features a low voltage control logic interface (on/off interface) that can interface with low voltage digital control without extra level shifting circuit. It also integrates an output discharge switch that enables fast shutdown load discharge. When the switch is off, it provides the reverse blocking to prevent high current flowing into the power source.

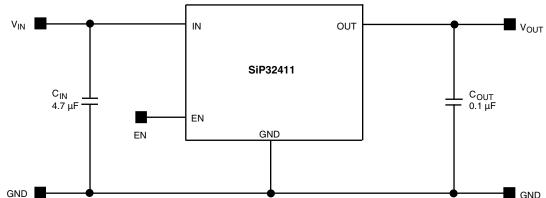
The SiP32411DN is in TDFN4 package of 1.2 mm by 1.6 mm. It supports over 2 A of continuous current. The SiP32411DR is in SC70-6 package.

FEATURES

- 1.1 V to 5.5 V operation voltage range
- 62 m Ω typical from 2 V to 5 V for SiP32411DN
- 101 m Ω typical from 2 V to 5 V for SiP32411DR
- Low R_{ON} down to 1.2 V
- Slew rate controlled turn-on: 150 µs at 3.6 V
- Fast shutdown load discharge
- Low quiescent current < 1 µA when disabled
 - 6.7 µA at V_{IN} = 1.2 V
- Switch off reversed blocking
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Cellular phones
- · Portable media players
- Digital camera
- GPS
- Computers
- · Portable instruments and healthcare devices



TYPICAL APPLICATION CIRCUIT



ORDERING INFORMATION					
TEMPERATURE RANGE PACKAGE MARKING PART NUMBER					
-40 °C to 85 °C	SC70-6	MBxx	SiP32411DR-T1-GE3		
-40 0 10 85 0	TDFN4 1.2 mm x 1.6 mm	Ex	SiP32411DNP-T1-GE4		

Notes

x = lot code

• -GE3 and -GE4 denotes halogen-free and RoHS-compliant

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ABSOLUTE MAXIMUM RATINGS	5			
PARAMETER	LIMIT	UNIT		
Supply Input Voltage (VIN)		-0.3 to 6		
Enable Input Voltage (V _{EN})		-0.3 to 6	V	
Output Voltage (V _{OUT})		-0.3 to V _{IN} +0.3		
Maximum Continuous Switch Current (I _{max})	SC70-6 package	1.8		
Maximum Continuous Switch Current (Imax.)	TDFN4 1.2 mm x 1.6 mm	2.4	А	
Maximum Pulsed Current (I _{DM}) V _{IN}	SC70-6 package	2.2	A	
(pulsed at 1 ms, 10 % duty cycle)	TDFN4 1.2 mm x 1.6 mm	3	7	
ESD Rating (HBM)		4000	V	
Junction Temperature (T _J)		-40 to 125	°C	
Thermal Resistance (0,) a	6 pin SC70-6 ^b	240	°C/W	
Thermal Resistance (θ_{JA}) ^a	4 pin TDFN4 1.2 mm x 1.6 mm ^c	170	0/10	
Deriver Dissipation (\mathbf{D}_{i})	6 pin SC70- 6 ^b	230	ma\\//	
Power Dissipation (P _D) ^a	4 pin TDFN4 1.2 mm x 1.6 mm c 324		— mW	

Notes

a. Device mounted with all leads and power pad soldered or welded to PC board, see PCB layout.

b. Derate 4.5 mW/°C above $T_A = 70$ °C, see PCB layout.

c. Derate 5.9 mW/°C above T_A = 70 °C, see PCB layout.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating/conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING RANGE			
PARAMETER	LIMIT	UNIT	
Input Voltage Range (V _{IN})	1.1 to 5.5	V	
Operating Temperature Range	-40 to 85	°C	



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SPECIFICATIONS								
PARAMETER	SYMBOL		CONDITIONS UNLESS SPECIFIED $V_{IN} = 5$, $T_A = -40$ °C to 85 °C	LIMITS -40 °C TO 85 °C			UNIT	
		(Typical values are at $T_A = 25$ °C)		MIN. ^a	TYP. ^b	MAX. a		
Operating Voltage ^c	V _{IN}			1.5	-	5.5	V	
			V _{IN} = 1.2 V, EN = active	-	6.7	14		
			V _{IN} = 1.8 V, EN = active	-	14	24		
Quiaccent Current	1	$V_{IN} = 2.5 V, EN = active$		-	25	40		
Quiescent Current	Ι _Q	$V_{IN} = 3.6 V, EN = active$		-	40	60		
			$V_{IN} = 4.3 V$, EN = active	-	52	75	μA	
			$V_{IN} = 5 V, EN = active$	-	71	99		
Off Supply Current	I _{Q(off)}		EN = inactive, OUT = open	-	-	1		
Off Switch Current	I _{DS(off)}		EN = inactive, OUT = GND		-	1		
Reverse Blocking Current	I _{RB}	V _{OUT}	= 5 V, V_{IN} = 1.2 V, V_{EN} = inactive	-	-	10		
			V_{IN} = 1.2 V, I_L = 100 mA, T_A = 25 °C	-	105	125		
			V_{IN} = 1.8 V, I_L = 100 mA, T_A = 25 $^\circ C$	-	101	120	.a V .u V .u μA .u .u .u .u .u .u .u .u .u .u .u .u	
		SC70-6	V_{IN} = 2.5 V, I_L = 100 mA, T_A = 25 $^\circ C$	-	101	120		
		00/0 0	V_{IN} = 3.6 V, I_L = 100 mA, T_A = 25 $^\circ C$	-	101	120		
			$V_{IN}=4.3$ V, $I_L=100$ mA, $T_A=25\ ^\circ C$	-	101	120		
On-Resistance	R _{DS(on)}		V_{IN} = 5 V, I_L = 100 mA, T_A = 25 °C	-	101	120	mO	
On-nesistance	TUS(on)	TDFN4 1.2 mm x 1.6 mm	V_{IN} = 1.2 V, I_L = 100 mA, T_A = 25 °C	-	66	76	-	
			V_{IN} = 1.8 V, I_L = 100 mA, T_A = 25 °C	-	62	72		
			$V_{IN} = 2.5 \text{ V}, I_L = 100 \text{ mA}, T_A = 25 ^\circ\text{C}$	-	62	72		
			V_{IN} = 3.6 V, I_L = 100 mA, T_A = 25 °C	-	62	72		
			V_{IN} = 4.3 V, I_L = 100 mA, T_A = 25 °C	-	62	72		
			V_{IN} = 5 V, I_L = 100 mA, T_A = 25 °C	-	62	72		
On-Resistance	TC _{RDS}		SC70-6 package	-	4300	-	ppm/°C	
Temperature-Coefficient	- CRDS	TDI	FN4 1.2 mm x 1.6 mm package	-	3400	-	pp, 0	
		V _{IN} = 1.2 V		-	-	0.3	-	
		V _{IN} = 1.8 V		-	-	0.4 ^d		
EN Input Low Voltage c	V _{IL}	V _{IN} = 2.5 V		-	-	0.5 ^d		
	• IL		V _{IN} = 3.6 V	-	-	0.6 ^d		
			V _{IN} = 4.3 V	-	-	0.7 ^d		
			$V_{IN} = 5 V$	-	-	0.8 ^d	v	
			V _{IN} = 1.2 V	0.9 ^d	-	-		
			V _{IN} = 1.8 V	1.2 ^d	-	-	_	
EN Input High Voltage ^c	V _{IH}		V _{IN} = 2.5 V	1.4 ^d	-	-		
1 0 0			V _{IN} = 3.6 V	1.6 ^d	-	-		
		$V_{IN} = 4.3 V$		1.7 ^d	-	-	4	
			$V_{IN} = 5 V$	1.8	-	-	<u> </u>	
EN Input Leakage			$V_{EN} = 5.5 V$	-1	-	1		
Output Pulldown Resistance	R _{PD}		EN = inactive, $T_A = 25 \text{ °C}$	-	217	280	Ω	
Output Turn-On Delay Time	t _{d(on)}			-	140	210	4	
Output Turn-On Rise Time	t _(on)	V _{IN} =	= 3.6 V, R_{load} = 10 Ω , T_A = 25 °C	80	150	220	μs	
Output Turn-Off Delay Time	t _{d(off)}			-	0.27	1		

Notes

a. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum.

b. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

c. For $V_{\mbox{\scriptsize IN}}$ outside this range consult typical EN threshold curve.

d. Not tested, guarantee by design.

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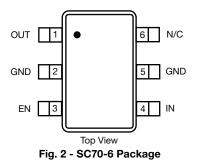
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PIN CONFIGURATION



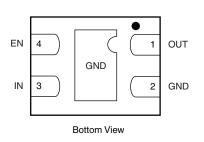


Fig. 3 - TDFN4 1.2 mm x 1.6 mm Package

PIN DE	SCRIPTIC	N	
PIN NU	IMBER	NAME	FUNCTION
SC70-6	TDFN4	NAME	T CNOTION
4	3	IN	This pin is the n-channel MOSFET drain connection. Bypass to ground through a 2.2 μ F capacitor
2, 5	2	GND	Ground connection
3	4	EN	Enable input
1	1	OUT	This pin is the n-channel MOSFET source connection. Bypass to ground through a 0.1 μ F capacitor

TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

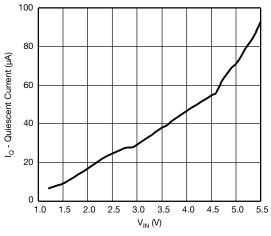
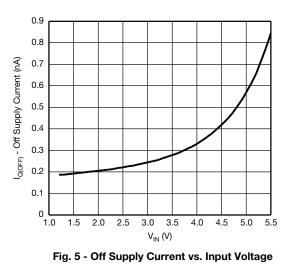


Fig. 4 - Quiescent Current vs. Input Voltage



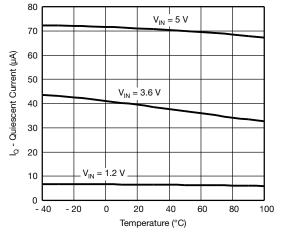


Fig. 6 - Quiescent Current vs. Temperature

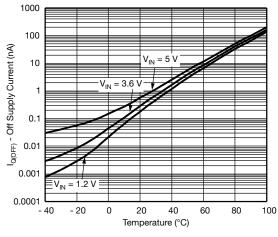


Fig. 7 - Off Supply Current vs. Temperature

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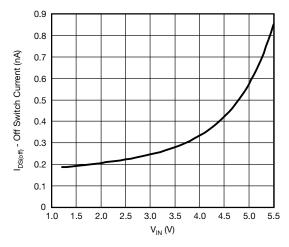


Fig. 8 - Off Switch Current vs. Input Voltage

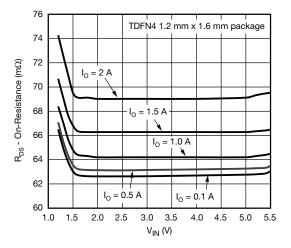
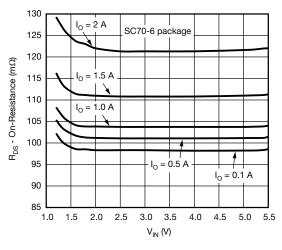


Fig. 9 - R_{DS(on)} vs. V_{IN} for TDFN4 package





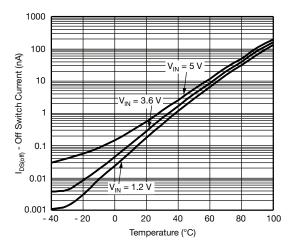


Fig. 11 - Off Switch Current vs. Temperature

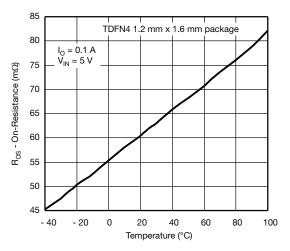


Fig. 12 - R_{DS(on}) vs. Temperature for TDFN4 package

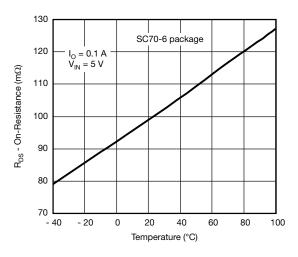


Fig. 13 - R_{DS(on)} vs. Temperature for SC70-6 package

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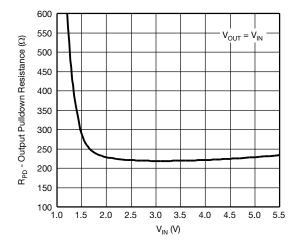


Fig. 14 - Output Pull Down vs. Input Voltage

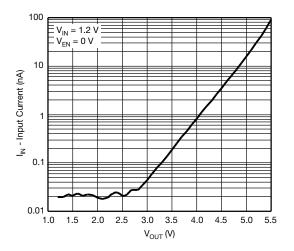


Fig. 15 - Reverse Blocking Current vs. Output Voltage

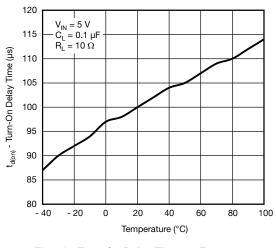


Fig. 16 - Turn-On Delay Time vs. Temperature

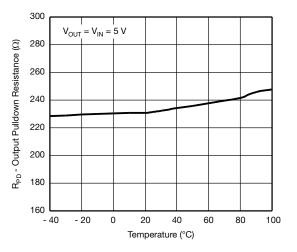


Fig. 17 - Output Pull Down vs. Temperature

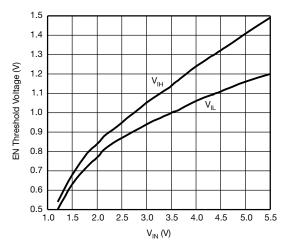


Fig. 18 - EN Threshold Voltage vs. Input Voltage

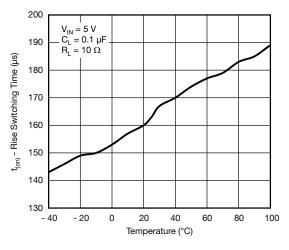


Fig. 19 - Rise Time vs. Temperature

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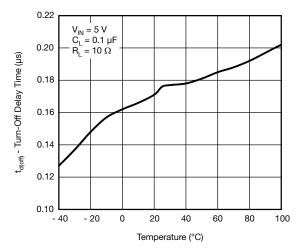


Fig. 20 - Turn-Off Delay Time vs. Temperature

TYPICAL WAVEFORMS

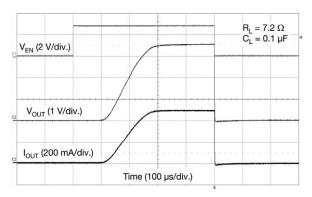


Fig. 21 - Switching ($V_{IN} = 3.6 V$)

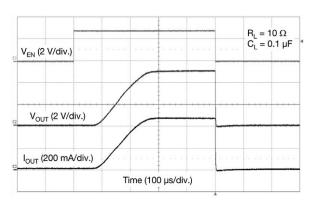


Fig. 22 - Switching ($V_{IN} = 5 V$)

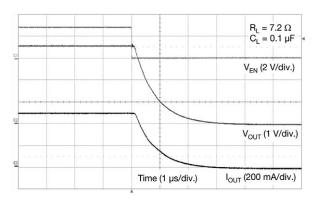


Fig. 23 - Turn-Off (V_{IN} = 3.6 V)

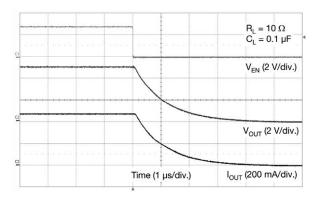


Fig. 24 - Turn-Off (V_{IN} = 5 V)



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BLOCK DIAGRAM

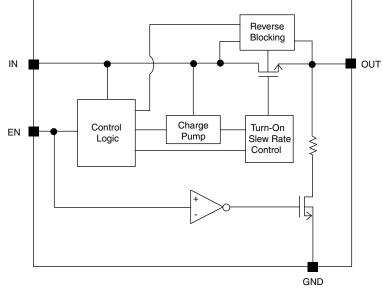


Fig. 25 - Functional Block Diagram

PCB LAYOUT

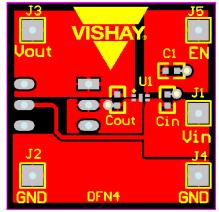


Fig. 26 - Top, PCB Layout for TDFN4 1.2 mm x 1.6 mm (board size: 1 inch x 1 inch)

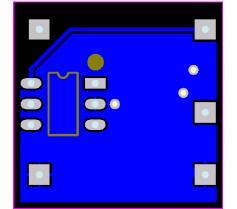


Fig. 27 - Bottom, PCB Layout for TDFN4 1.2 mm x 1.6 mm (board size: 1 inch x 1 inch)

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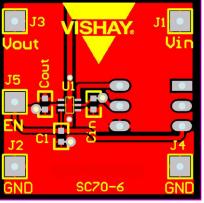


Fig. 28 - Top, PCB Layout for SC70-6 (board size: 1 inch x 1 inch)

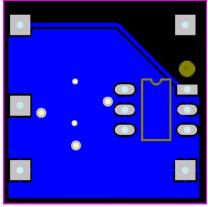


Fig. 29 - Bottom, PCB Layout for SC70-6 (board size: 1 inch x 1 inch)

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DETAILED DESCRIPTION

SiP32411 is an n-channel power MOSFET designed as high side load switch with slew rate control to prevent in-rush current. Once enable the device charge pumps the gate of the power MOSFET to 5 V gate to source voltage while controlling the slew rate of the turn on time. The mostly constant gate to source voltage keeps the on resistance low through out the input voltage range. When disable, the output discharge circuit turns on to help pull the output voltage to ground more quickly. Also in disable mode, the reverse blocking circuit is activated to prevent current from going back to the input in case the output voltage is higher than the input voltage. Input voltage is needed for the reverse blocking circuit to work properly, it can be as low as V_{IN(min.)}.

APPLICATION INFORMATION

Input Capacitor

While a bypass capacitor on the input is not required, a 2.2 µF or larger capacitor for CIN is recommended in almost all applications. The bypass capacitor should be placed as physically close as possible to the SiP32411 to be effective in minimizing transients on the input. Ceramic capacitors are recommended over tantalum because of their ability to withstand input current surges from low impedance sources such as batteries in portable devices.

Output Capacitor

A 0.1 µF capacitor or larger across V_{OUT} and GND is recommended to insure proper slew operation. COUT may be increased without limit to accommodate any load transient condition with only minimal affect on the SiP32411 turn on slew rate time. There are no ESR or capacitor type requirement.

Enable

The EN pin is compatible with both TTL and CMOS logic voltage levels.

Protection Against Reverse Voltage Condition

The SiP32411 contains a reverse blocking circuitry to protect the current from going to the input from the output in case where the output voltage is higher than the input voltage when the main switch is off. A supply voltage as low as the minimum required input voltage is necessary for this circuitry to work properly.

Thermal Considerations

The SiP32411 is designed to maintain a constant output load current. Due to physical limitations of the layout and assembly of the device the maximum switch current is 1.8 A

for SC70-6 package and 2.4 A for TDFN4 package, as stated in the Absolute Maximum Ratings table. However, another limiting characteristic for the safe operating load current is the thermal power dissipation of the package. To obtain the highest power dissipation (and a thermal resistance of 240 °C/W for SC70-6 and 170 °C/W for TDFN4) the power pad of the device should be connected to a heat sink on the printed circuit board.

The maximum power dissipation in any application is dependent on the maximum junction temperature, $T_{J(max.)} = 125 \text{ °C}$, the junction-to-ambient thermal resistance for the TDFN4 1.2 mm x 1.6 mm package, $\theta_{J-A} = 170 \text{ °C/W}$, and the ambient temperature, T_A, which may be formulaically expressed as:

P (max.) =
$$\frac{T_{J (max.)} - T_{A}}{\theta_{J-A}} = \frac{125 - T_{A}}{170}$$

It then follows that, assuming an ambient temperature of 70 °C, the maximum power dissipation will be limited to about 324 mW.

So long as the load current is below the 2.4 A limit, the maximum continuous switch current becomes a function two things: the package power dissipation and the R_{DS(on)} at the ambient temperature.

As an example let us calculate the worst case maximum load current at T_A = 70 °C. The worst case R_{DS(on)} at 25 °C occurs at an input voltage of 1.2 V and is equal to 75 m Ω . The R_{DS(on)} at 70 °C can be extrapolated from this data using the following formula

 $R_{DS(on)}$ (at 70 °C) = $R_{DS(on)}$ (at 25 °C) x (1 + $T_C \times \Delta T$)

Where T_C is 3400 ppm/°C. Continuing with the calculation we have

 $R_{DS(on)}$ (at 70 °C) = 75 m Ω x (1 + 0.0034 x (70 °C - 25 °C)) = 86.5 mΩ

The maximum current limit is then determined by

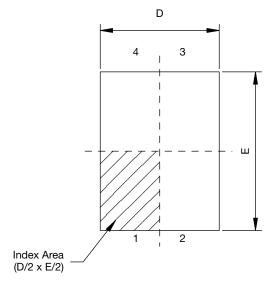
$$I_{LOAD (max.)} < \sqrt{\frac{P (max.)}{R_{DS(on)}}}$$

which in case is 1.94 A. Under the stated input voltage condition, if the 1.94 A current limit is exceeded the internal die temperature will rise and eventually, possibly damage the device.

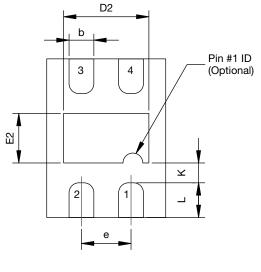
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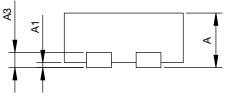
TDFN4 1.2 x 1.6 Case Outline



Top View



Bottom View



Side View

DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.45	0.55	0.60	0.017	0.022	0.024	
A1	0.00	-	0.05	0.00	-	0.002	
A3	0.1	5 REF. or 0.127 REF	. (1)		0.006 or 0.005 ⁽¹⁾		
b	0.20	0.25	0.30	0.008	0.010	0.012	
D	1.15	1.20	1.25	0.045	0.047	0.049	
D2	0.81	0.86	0.91	0.032	0.034	0.036	
е		0.50 BSC		0.020			
E	1.55	1.60	1.65	0.061	0.063	0.065	
E2	0.45	0.50	0.55	0.018	0.020	0.022	
К		0.25 typ.			0.010 typ.		
L	0.25	0.30	0.35	0.010	0.012	0.014	
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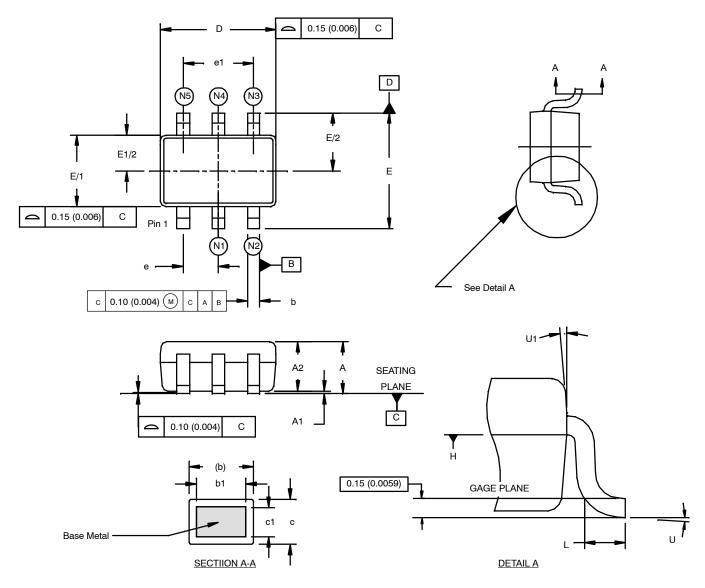
Note

⁽¹⁾ The dimension depends on the leadframe that assembly house used.

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SC-70: 3/4/5/6-LEADS (PIC ONLY)



Pin Code	LEAD COUNT					
	3	4	5	6		
N1	-	-	2	2		
N2	2	2	3	3		
N3	-	3	4	4		
N4	3	-	-	5		
N5	-	4	5	6		

NOTES:

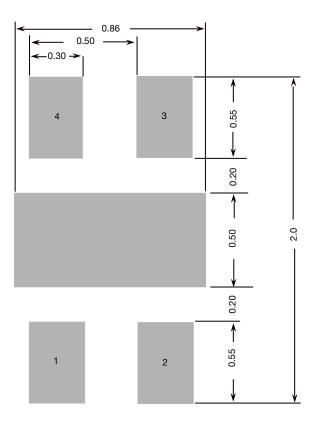
- 1. Dimensioning and tolerancing per ANSI Y14.5M-1994.
- 2. Controlling dimensions: millimeters converted to inch dimensions are not necessarily exact.
- Dimension "D" does not include mold flash, protrusion or gate burr. Mold flash, protrusion or gate burr shall not exceed 0.15 mm (0.006 inch) per side.
- 4. The package top shall be smaller than the package bottom. Dimension "D" and "E1" are determined at the outer most extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.



	Μ	ILLIMETE	INCHES				
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.80	-	1.10	0.031	-	0.043	
A1	0.00	-	0.10	0.000	-	0.004	
A2	0.80	0.90	1.00	0.031	0.035	0.040	
b	0.15	-	0.30	0.006	-	0.012	
b1	0.15	0.20	0.25	0.006	0.008	0.010	
С	0.08	-	0.25	0.003	-	0.010	
c1	0.08	0.13	0.20	0.003	0.005	0.008	
D	1.90	2.10	2.15	0.074	0.082	0.084	
Е	2.00	2.10	2.20	0.078	0.082	0.086	
E ₁	1.15	1.25	1.35	0.045	0.050	0.055	
е		0.65 BSC	0.65 BSC 0.0255 BSC				
e ₁		1.30 BSC		0.0512 BSC			
L	0.26	0.36	0.46	0.010	0.014	0.018	
U	0°	-	8 °	0°	-	8°	
U1	4°		10°	4°		10°	



RECOMMENDED MINIMUM PADS FOR TDFN4 1.2 x 1.6



Recommended Minimum Pads Dimensions in mm



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